10/010,696



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

re Patent Application of:

Visvamohan Yegnashankaran et al.

Appln. No.: 10/010,696

Filed: December 5, 2001

For: MULTILEVEL METAL INTERCONNECT WITH CAPACITIVE STRUCTURES THAT ADJUST THE CAPACITANCE OF

THE INTERCONNECT

Group Art Unit: 2811

Examiner: VU, QUANG D

AMENDMENT IN RESPONSE TO OFFICE ACTION MAILED SEPTEMBER 23, 2004

INTRODUCTORY COMMENTS

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed September 23, 2004, please amend the above-identified applications as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper;

Remarks which begin on page 10 of this paper;

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service, postage prepaid, in an envelope, addressed to Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on 01-24-05

Dated ALLIALL 24, 2005 By

AMENDMENT IN RESPONSE TO OFFICE ACTION DATED SEPTEMBER 23, 2004

Atty. Docket No. 100-16201 (P05088-C1)